

**Product Summary**

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-20V	13.5mΩ@-4.5V	-11A
	16mΩ@-2.5V	



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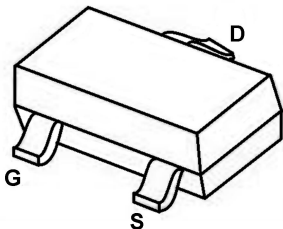
**Feature**

- High power and current handing capability
- Surface mount package

**Application**

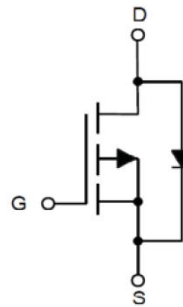
- Battery Switch
- DC/DC Converter

**Package**

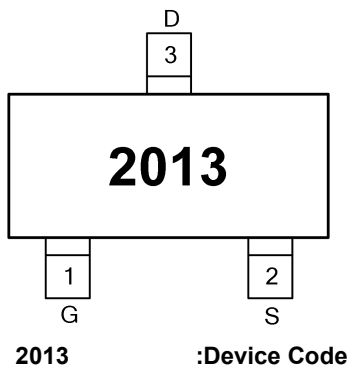


SOT-23-3L

**Circuit diagram**



**Marking**



**Order Information**

Device	Package	Unit/Tape
SP2013T1	SOT-23-3L	3000

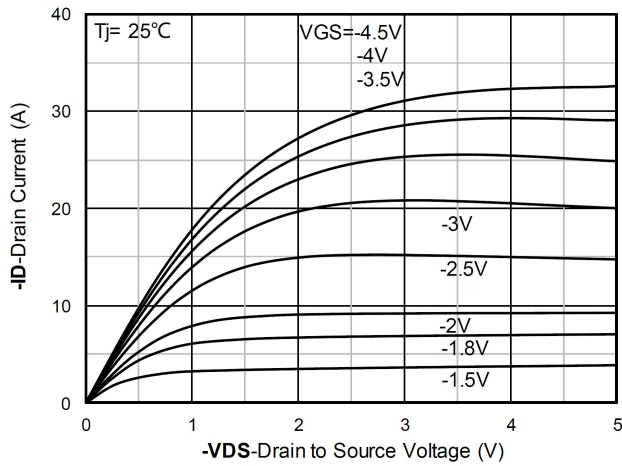
**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate-Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current	I <sub>D</sub>	-11	A
Pulse Drain Current Tested	I <sub>DM</sub>	-44	A
Power Dissipation	P <sub>D</sub>	1.3	W
Thermal Resistance Junction-to-Ambient	R <sub>θJA</sub>	96	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C

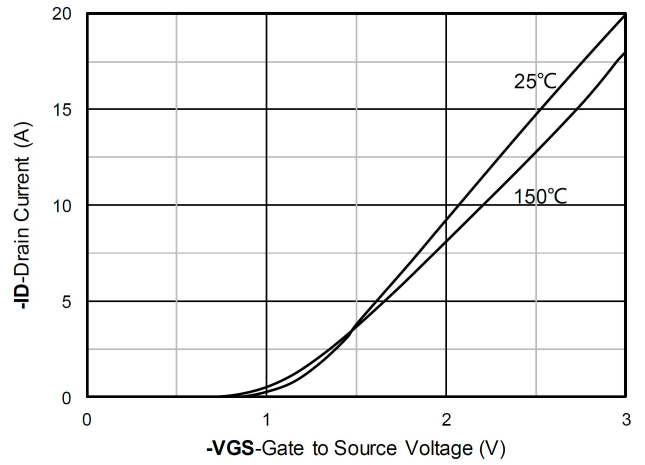
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V , I <sub>D</sub> =-250μA	-20	-	-	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V	-	-	-1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V , V <sub>DS</sub> =0V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.4	-0.7	-1.0	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A	-	13.5	17	mΩ
		V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-4A	-	16	25	
<b>Dynamic characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-10V , V <sub>GS</sub> =0V , f=1MHz	-	1800	-	pF
Output Capacitance	C <sub>oss</sub>		-	215	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	176	-	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-10V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-7A	-	16	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	4.3	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	3.6	-	
<b>Switching Characteristics</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-6V V <sub>GS</sub> =-4.5V , R <sub>G</sub> =3Ω, I <sub>D</sub> =-7A	-	8	-	nS
Turn-On Rise Time	t <sub>r</sub>		-	34	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	65	-	
Turn-Off Fall Time	t <sub>f</sub>		-	70	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C	-	-	-1.2	V

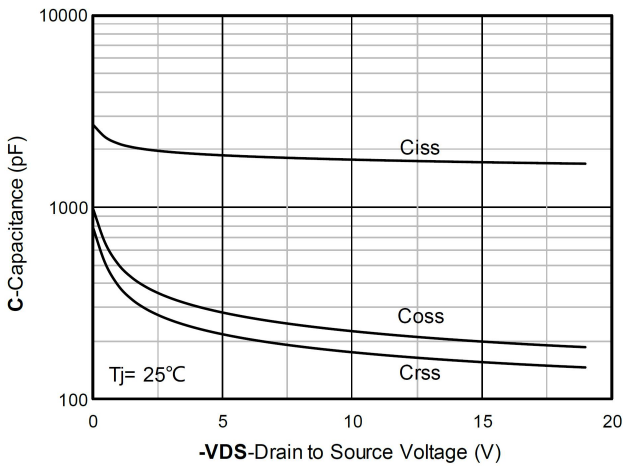
Typical Characteristics



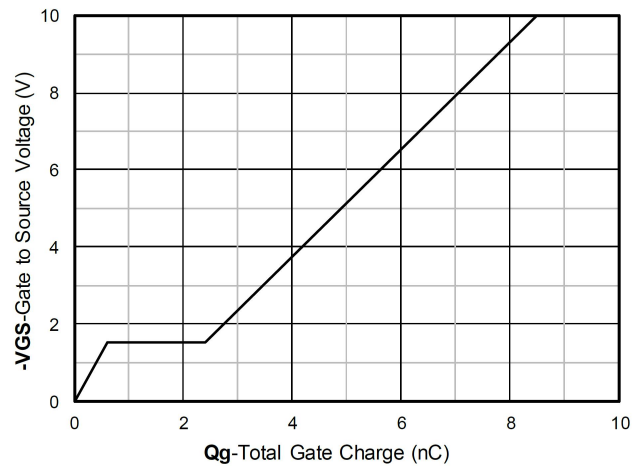
Output Characteristics



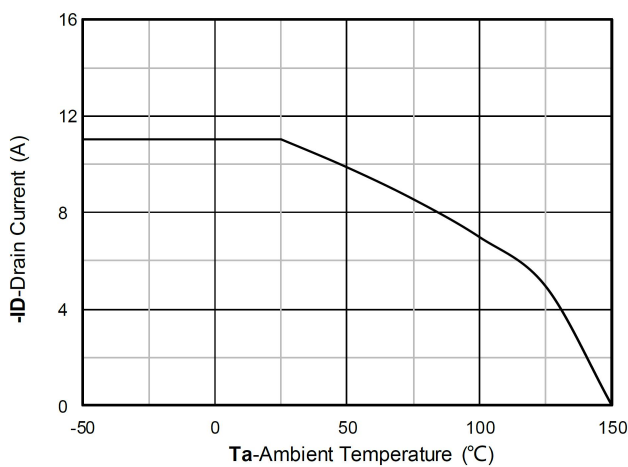
Transfer Characteristics



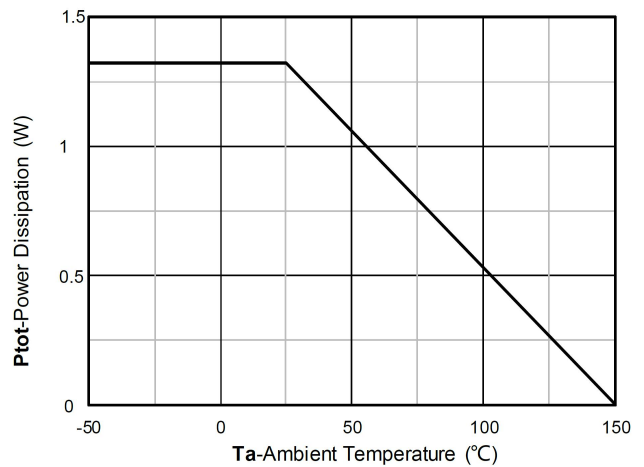
Capacitance Characteristics



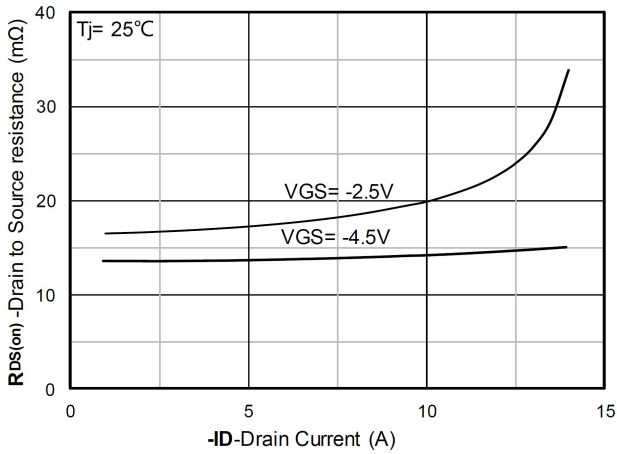
Gate Charge



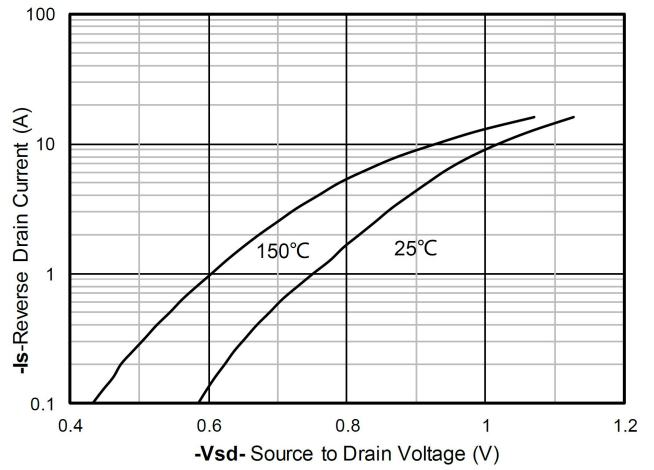
Current dissipation



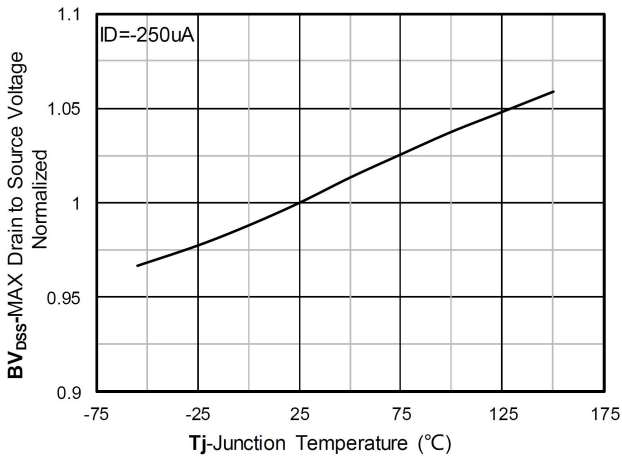
Power dissipation



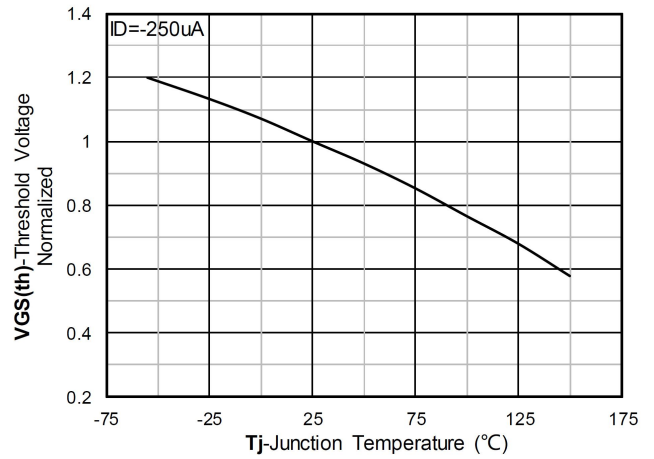
RDS(on) VS Drain Current



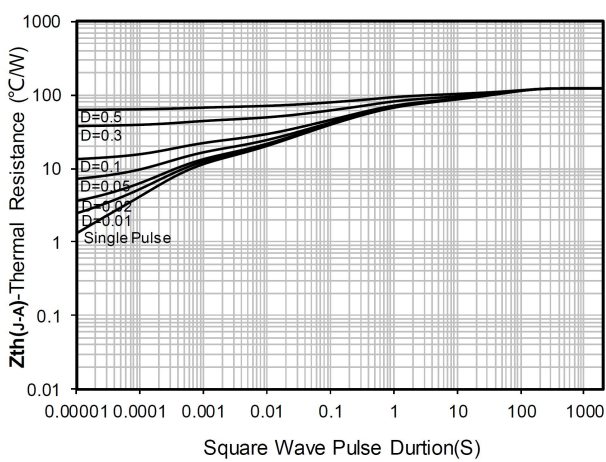
Forward characteristics of reverse diode



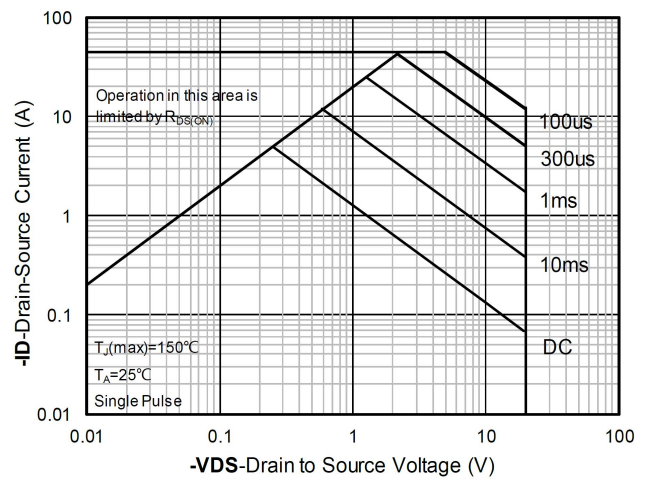
Normalized breakdown voltage



Normalized Threshold voltage

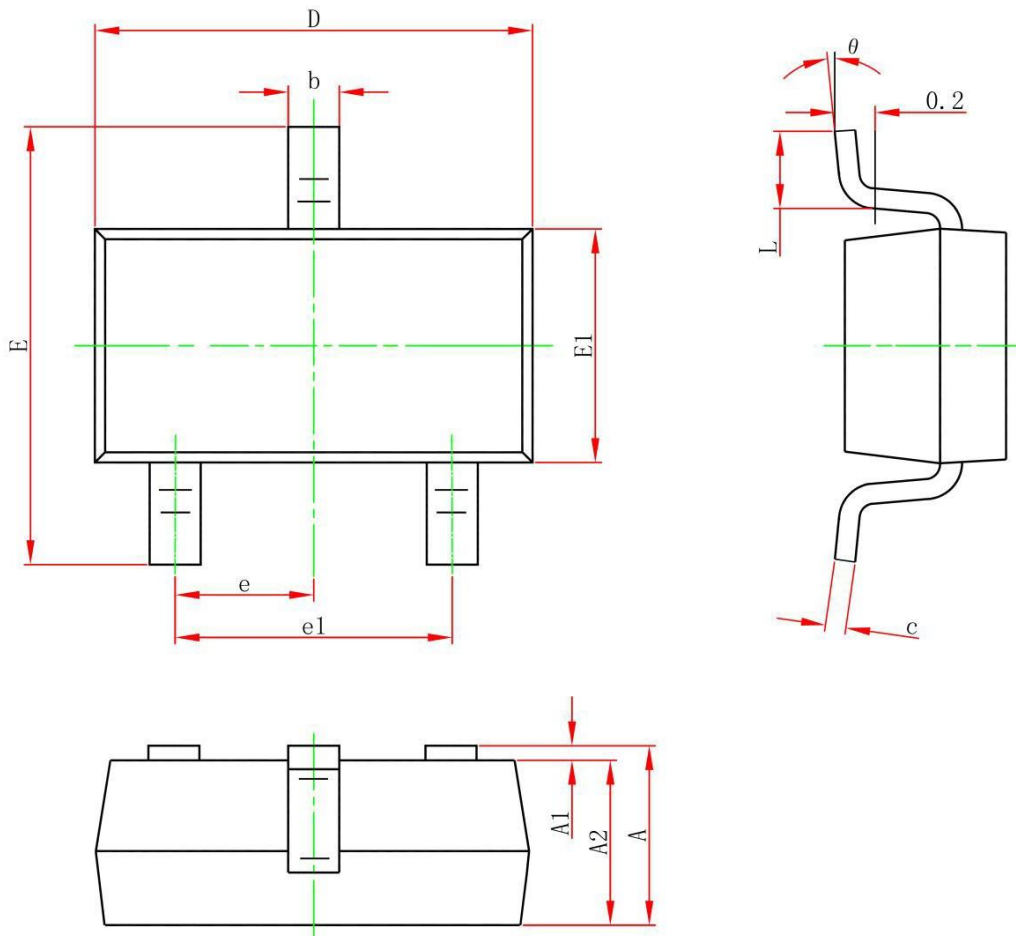


Maximum Transient Thermal Impedance



Safe Operation Area

**SOT-23-3L Package Information**



Symbol	Dimensions in millimeters	
	Min.	Max.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950 Typ.	
e1	1.800	2.000
L	0.300	0.600
$\theta$	0°	8°